

EAST Search History

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
S1	98777	(die or wafer) same order\$3	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2008/01/07 18:42
S2	25	(die or wafer) with order\$3 and ic and "705"/\$\$	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2008/01/09 12:53
S3	33	(die or wafer) with order\$3 and ic and pricing	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2008/01/09 12:50
S4	2	"20020046147"	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2008/01/09 15:30
S5	171	(die or wafer or chip\$1 or ic) and customer with order\$3 and ic and pricing	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2008/01/09 12:51
S6	69	(die or wafer or chip\$1 or ic) and customer with order\$3 and ic and pricing and "705"/\$\$	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2008/01/09 12:55
S7	59	"705"/\$\$ and (@ad<"20040209" or @pd<"20040209" or @rlad<"20040209" or @prad<"20040209") and (die or wafer\$1 or chip\$1 or ic) and customer with order\$3 and ic and pricing	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2008/01/09 12:56

EAST Search History

S8	59	"705"/\$\$ and (@ad<"20040209" or @pd<"20040209" or @rlad<"20040209" or @prad<"20040209") and (reticle or die or wafer\$1 or chip\$1 or ic) and customer with order\$3 and ic and pricing	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2008/01/09 13:00
S9	0	"705"/\$\$ and (@ad<"20040209" or @pd<"20040209" or @rlad<"20040209" or @prad<"20040209") and (reticle or die or wafer\$1 or chip\$1 or ic) and customer with order\$3 and ic and pricing and schinella	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2008/01/09 13:00
S10	0	("20040006485" and "5663017")	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2008/01/09 13:01
S11	50	("20040006485" or "5663017")	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2008/01/09 13:02
S12	8	("20040006485" or "5663017") and order\$3 with form\$1	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2008/01/09 13:03
S13	6	("20040006485" or "5663017") and (form41 or document\$1 or bill or bom or order near2 form\$1)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2008/01/09 13:04
S14	50	("20040006485" or "5663017") and (form\$1 or document\$1 or bill or bom or order near2 form\$1)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2008/01/09 13:06

EAST Search History

S15	50	("20040006485" or "5663017")	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2008/01/09 13:08
S16	52	("20040006485" or "5663017" or "20020143424")	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2008/01/09 13:08
S17	2	"20030149953"	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2008/01/09 15:31
S18	2	"20030144953"	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2008/01/09 15:31
S19	2875	(die or wafer) and order\$3 near3 (form\$1 or sheet\$1) and extract\$3 and semiconductor\$1	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2008/01/21 18:38
S20	1157	(die or wafer) and order\$3 near3 (form\$1 or sheet\$1) and extract\$3 and semiconductor\$1 and analysis and (report\$3 or summar\$3)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2008/01/21 18:39
S21	60	(die or wafer) and customer near4 order\$3 and (form\$1 or sheet\$1) and extract\$3 and semiconductor\$1 and analysis and (report\$3 or summar\$3)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2008/01/21 18:39

EAST Search History

S22	32	(die or wafer) and customer near4 order\$3 and (form\$1 or sheet\$1) and extract\$3 and semiconductor\$1 and analysis and (report\$3 or summar\$3) and sales	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2008/01/21 18:40
S23	23	"705"/\$\$ and (@ad<"20040209" or @pd<"20040209" or @rlad<"20040209" or @prad<"20040209") and (die or wafer) and customer near4 order\$3 and (form\$1 or sheet\$1) and extract\$3 and semiconductor\$1 and analysis and (report\$3 or summar\$3) and sales	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2008/01/21 18:40
S24	130	(@ad<"20040209" or @pd<"20040209" or @rlad<"20040209" or @prad<"20040209") and (chip\$1 or die or wafer) and customer with order\$3 and (form\$1 or sheet\$1) and extract\$3 and semiconductor\$1 and analysis and (report\$3 or summar\$3) and sales	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2008/01/21 18:42
S25	25	(@ad<"20040209" or @pd<"20040209" or @rlad<"20040209" or @prad<"20040209") and (chip\$1 or die or wafer) with (pric\$3 or cost\$3 or quote\$1 or rfq) and customer with order\$3 and (form\$1 or sheet\$1) and extract\$3 and semiconductor\$1 and analysis and (report\$3 or summar\$3) and sales	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2008/01/21 18:44
S26	2	weed and (chip\$1 or die or wafer) with (pric\$3 or cost\$3 or quote\$1 or rfq) and customer with order\$3	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2008/01/21 18:46
S27	19	weed and (chip\$1 or die or wafer) with (pric\$3 or cost\$3 or quote\$1 or rfq) and customer and order\$3	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2008/01/21 18:46

EAST Search History

S28	104	weed and (chip\$1 or die or wafer\$1) with (pric\$3 or cost\$3 or quote\$1 or rfq)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2008/01/21 18:47
S29	0	(@ad<"20040209" or @pd<"20040209" or @rlad<"20040209" or @prad<"20040209") and global near3 pricing and (chip\$1 or die or wafer) and customer\$1 and order\$3 and semiconductor\$1 and analysis and (report\$3 or summar\$3) and sales	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2008/01/21 18:50
S30	0	(@ad<"20040209" or @pd<"20040209" or @rlad<"20040209" or @prad<"20040209") and global near3 pricing and (chip\$1 or die or wafer) and customer\$1 and semiconductor\$1 and analysis and (report\$3 or summar\$3) and sales	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2008/01/21 18:50
S31	0	(@ad<"20040209" or @pd<"20040209" or @rlad<"20040209" or @prad<"20040209") and global near3 pricing and (chip\$1 or die or wafer) and customer\$1 and semiconductor\$1 and (report\$3 or summar\$3) and sales	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2008/01/21 18:50
S32	11	(@ad<"20040209" or @pd<"20040209" or @rlad<"20040209" or @prad<"20040209") and global with pricing and (chip\$1 or die or wafer) and customer\$1 and semiconductor\$1 and (report\$3 or summar\$3) and sales	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2008/01/21 18:50
S33	17	(@ad<"20040209" or @pd<"20040209" or @rlad<"20040209" or @prad<"20040209") and global with pricing and (chip\$1 or die or wafer) and customer\$1 and (report\$3 or summar\$3) and sales	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2008/01/21 18:51

EAST Search History

S34	10	(@ad<"20040209" or @pd<"20040209" or @rlad<"20040209" or @prad<"20040209") and global with pricing and (chip\$1 or die or wafer\$1) same (pric\$3 or cost\$3 or fee or fees or charg\$3) and (report\$3 or summar\$3) and sales	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2008/01/21 18:52
S35	21	(@ad<"20040209" or @pd<"20040209" or @rlad<"20040209" or @prad<"20040209") and global same pricing and (chip\$1 or die or wafer\$1) same (pric\$3 or cost\$3 or fee or fees or charg\$3) and (report\$3 or summar\$3) and sales	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2008/01/21 18:53
S36	4	(@ad<"20040209" or @pd<"20040209" or @rlad<"20040209" or @prad<"20040209") and negotiat\$4 same pric\$3 with (chip\$1 or die or wafer\$1 or ic)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2008/01/22 00:55